#### 54AC16620, 74AC16620 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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- Members of the Texas Instruments Widebus™ Family
- 3-State Outputs Drive Bus Lines Directly
- Flow-Through Architecture Optimizes PCB Layout
- Distributed V<sub>CC</sub> and GND Pin Configurations Minimize High-Speed Switching Noise
- EPIC<sup>™</sup> (Enhanced-Performance Implanted CMOS) 1-µm Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) Packages Using 25-mil Center-to-Center Pin Spacings and 380-mil Fine-Pitch Ceramic Flat (WD) Packages Using 25-mil Center-to-Center Pin Spacings

#### description

The 'AC16620 are inverting 16-bit transceivers designed for asynchronous communication between data buses. The control-function implementation allows for maximum flexibility in timing.

These devices can be used as two 8-bit transceivers or one 16-bit transceiver. They allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the complementary output-enable (OEAB or OEBA) inputs. The output-enable inputs can be used to disable the device so that the buses are effectively isolated.

54AC16620 . . . WD PACKAGE 74AC16620 . . . DL PACKAGE (TOP VIEW)

1		$\overline{}$	1
10EAB[	1	48	1 <mark>OEBA</mark>
1B1[	2	47	] 1A1
1B2	3	46	] 1A2
GND	4		GND
1B3		44	] 1A3
1B4		43	] 1A4
Vcc	7	42	∫ v <sub>cc</sub>
1B5		41	1A5
1B6			] 1A6
GND	10		GND
1B7	11		] 1A7
1B8			] 1A8
2B1	13		] 2A1
2B2			] 2A2
GND	15		GND
2B3	16		2A3
2B4	17		2A4
Vcc			] v <sub>cc</sub>
2B5	19		2A5
2B6	20		2A6
GND			GND
2B7	22		2A7
2B8	23		2A8
20EAB[	24	25	2 <mark>OEBA</mark>
			,

The dual-enable configuration gives the transceiver the capability to store data by simultaneously enabling OEAB and  $\overline{\text{OEBA}}$ . Each output reinforces its input in this transceiver configuration. Thus, when both control inputs are enabled and all other data sources to the two sets of bus lines are at high impedance, the bus lines remain at their last states.

The 74AC16620 is packaged in TI's shrink small-outline package, which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The 54AC16620 is characterized for operation over the full military temperature range of –55°C to 125°C. The 74AC16620 is characterized for operation from –40°C to 85°C.



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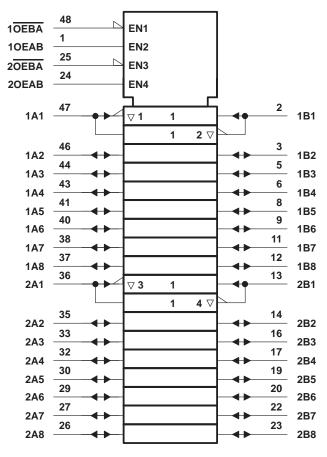
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## FUNCTION TABLE (each 8-bit section)

	•	
INP	UTS	ODED ATION
OEBA	OEAB	OPERATION
L	L	B data to A bus
L	Н	B data to A bus, A data to B bus
Н	L	Isolation
Н	Н	A data to B bus

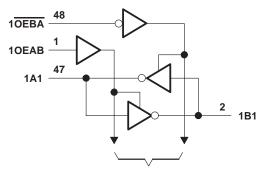
### logic symbol†

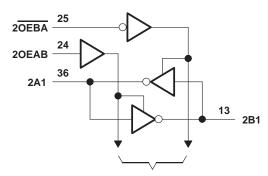


<sup>&</sup>lt;sup>†</sup>This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

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#### logic diagram (positive logic)





To Seven Other Channels

To Seven Other Channels

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	–0.5 V to 7 V
Input voltage range, V <sub>I</sub> (see Note 1)	0.5 V to V <sub>CC</sub> + 0.5 V
Output voltage range, VO (see Note 1)	0.5 V to V <sub>CC</sub> + 0.5 V
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ )	±20 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CC</sub> )	±50 mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )	±50 mA
Continuous current through V <sub>CC</sub> or GND	±400 mA
Maximum power dissipation at $T_A = 55^{\circ}$ C (in still air) (see Note 2): DL package	1.2 W
Storage temperature range, T <sub>Stq</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

  2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.



### 54AC16620, 74AC16620 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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#### recommended operating conditions (see Note 2)

			54	54AC16620			74AC16620		
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage		3	5	5.5	3	5	5.5	V
		VCC = 3 V	2.1			2.1			
$\vee_{IH}$	High-level input voltage	V <sub>CC</sub> = 4.5 V	3.15			3.15			V
		V <sub>CC</sub> = 5.5 V	3.85			3.85			
		V <sub>CC</sub> = 3 V			0.9			0.9	
$\vee_{IL}$	Low-level input voltage	V <sub>CC</sub> = 4.5 V		3	1.35			1.35	V
		V <sub>CC</sub> = 5.5 V		97	1.65			1.65	
VI	Input voltage		0	6	VCC	0		VCC	V
Vo	Output voltage		0 4	30	VCC	0		VCC	V
		VCC = 3 V	000		-4			-4	
ІОН	High-level output current	V <sub>CC</sub> = 4.5 V	4		-24			-24	mA
		V <sub>CC</sub> = 5.5 V			-24			-24	
		VCC = 3 V			12			12	
lOL	Low-level output current	V <sub>CC</sub> = 4.5 V			24			24	mA
		V <sub>CC</sub> = 5.5 V			24			24	
Δt/Δν	Input transition rise or fall rate		0		10	0		10	ns/V
TA	Operating free-air temperature		-55		125	-40		85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DA.	DAMETER	TEST CONDITIONS	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	T,	<sub>Δ</sub> = 25°C	54AC16620	74AC16620	UNIT
PAI	RAMETER	TEST CONDITIONS	VCC	MIN	TYP MAX	MIN MAX	MIN MAX	UNII
			3 V	2.9		2.9	2.9	
		I <sub>OH</sub> = -50 μA	4.5 V	4.4		4.4	4.4	
			5.5 V	5.4		5.4	5.4	
Vон		$I_{OH} = -4 \text{ mA}$	3 V	2.58		2.48	2.48	V
		I <sub>OH</sub> = -24 mA	4.5 V	3.94		3.8	3.8	
		10H = -24 IIIA	5.5 V	4.94		4.8	4.8	
		$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V			3.85	3.85	
			3 V		0.1	0.1	0.1	
		I <sub>OL</sub> = 50 μA	4.5 V		0.1	0.1	0.1	
			5.5 V		0.1	0.1	0.1	
VOL		I <sub>OL</sub> = 12 mA	3 V		0.36	0.44	0.44	\
		I <sub>OL</sub> = 24 mA	4.5 V		0.36	0.44	0.44	
		10L = 24 111A	5.5 V		0.36	0.44	0.44	
	_	I <sub>OL</sub> = 75 mA <sup>†</sup>	5.5 V			1.65	1.65	
Ц	Control inputs	V <sub>I</sub> = V <sub>CC</sub> or GND	5.5 V		±0.1	±1	±1	μΑ
loz‡	A or B ports	$V_O = V_{CC}$ or GND	5.5 V		±0.5	±5	±5	μΑ
Icc		$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V		8	80	80	μΑ
Ci	Control inputs	V <sub>I</sub> = V <sub>CC</sub> or GND	5 V		4.5			pF
C <sub>io</sub>	A or B ports	$V_O = V_{CC}$ or GND	5 V		16			pF

<sup>†</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

 $<sup>\</sup>mbox{\begin{tabular}{l} $\overset{\cdot}{+}$ For I/O ports, the parameter IOZ includes the input leakage current.} \end{tabular}$ 



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# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

DADAMETED	ARAMETER FROM		T,	T <sub>A</sub> = 25°C		54AC16620		74AC16620		UNIT
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
t <sub>PLH</sub>	A or B	B or A	2.7	6.1	8.7	2.7	9.7	2.7	9.7	no
t <sub>PHL</sub>	AUIB	BUIA	3.9	7.9	10.6	3.9	11.7	3.9	11.7	ns
<sup>t</sup> PZH	<u></u>	А	3.2	7.1	10	3.2	11.2	3.2	11.2	ns
tPZL	OEBA		4.5	11.1	13.5	4.5	15	4.5	15	115
<sup>t</sup> PHZ	ŌĒBĀ	А	5.3	7.4	9.5	5.3	10.2	5.3	10.2	ns
tPLZ			4.6	7	9.2	4.6	9.8	4.6	9.8	115
<sup>t</sup> PZH	OEAB	В	3.1	6.7	9.5	3.1	10.7	3.1	10.7	ns
tPZL	OLAB		4.4	9.6	13	4.4	14.5	4.4	14.5	115
<sup>t</sup> PHZ	OEAB	В	5	7.1	9.3	5	9.8	5	9.8	ns
t <sub>PLZ</sub>	OLAB	, b	4.4	6.8	8.9	4.4	9.4	4.4	9.4	115

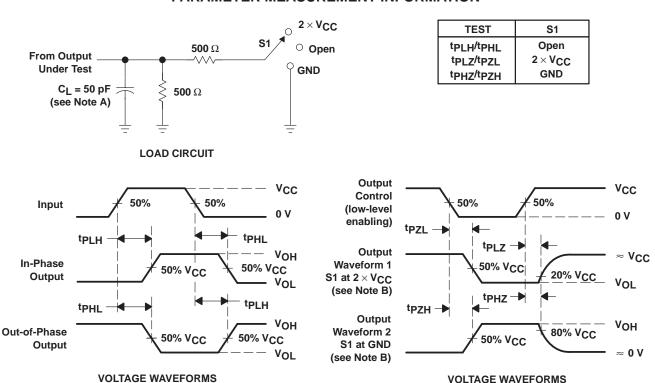
# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	T <sub>A</sub> = 25°C			54AC16620		74AC16620		UNIT
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNII
<sup>t</sup> PLH	A or B	B or A	2.1	3.9	6.1	2.1	6.8	2.1	6.8	ne
<sup>t</sup> PHL	A Or B	D OF A	3.1	4.9	7.3	3.1	8.2	3.1	8.2	ns
<sup>t</sup> PZH	<del></del> OEBA	A	2.2	4.3	6.8	2.2	7.6	2.2	7.6	ns
t <sub>PZL</sub>			3.3	5.5	8.4	3.3	9.4	3.3	9.4	115
<sup>t</sup> PHZ	ŌĒBĀ	BA A	4.9	6.6	8.6	4.9	9.2	4.9	9.2	ns
t <sub>PLZ</sub>			4.1	5.8	7.8	4.1	8.3	4.1	8.3	115
<sup>t</sup> PZH	OEAB	AB B	2.2	4.2	6.5	2.2	7.3	2.2	7.3	no
t <sub>PZL</sub>	UEAB		3.4	5.4	8.1	3.4	9.1	3.4	9.1	ns
<sup>t</sup> PHZ	OEAB		4.6	6.4	8.5	4.6	9	4.6	9	ns
tPLZ	OEAD	В	4.1	5.6	7.6	4.1	8	4.1	8	115

## operating characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$

	PARAMETER			TEST CON	TYP	UNIT	
Γ	C <sub>pd</sub>	Power dissipation capacitance per transceiver	Outputs enabled	C <sub>1</sub> = 50 pF,	f = 1 MHz	49	pF
			Outputs disabled	CL = 50 pr,	I = I IVIMZ	6	

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_{O} = 50~\Omega$ ,  $t_{f} = 3$  ns,  $t_{f} = 3$  ns.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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